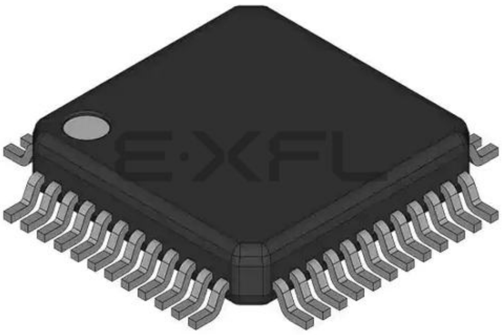

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	S08
Core Size	8-Bit
Speed	40MHz
Connectivity	CANbus, I²C, LINbus, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	39
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	6K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 16x12b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=mc9s08dv128mlf

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

NOTE

Setting DIV32 (bit 4) in MCGC3 is strongly recommended for FLL external modes when using a high frequency range (RANGE = 1) external reference clock.

3 Example # 1: Moving from FEI to PEE Mode: External Crystal = 8 MHz, Bus Frequency = 16 MHz

Location:	Section 8.5.3.1, Page 189

The first statement in step 2b should be “BLPE/PBE: MCGC3 = 0x48 (%01001000)”, and the second bullet in step 2b should be "DIV32 (bit 4) must be cleared when PLLS is set." The correct content should be:

a) BLPE: If a transition through BLPE mode is desired, first set LP (bit 3) in MCGC2 to 1.

b) BLPE/PBE: MCGC3 = 0x48 (%01001000)
   - PLLS (bit 6) set to 1, selects the PLL. At this time, with an RDIV value of %011, the FLL reference divider of 256 is switched to the PLL reference divider of 8 (see Table 8-3), resulting in a reference frequency of 8 MHz/ 8 = 1 MHz. In BLPE mode,changing the PLLS bit only prepares the MCG for PLL usage in PBE mode
   - DIV32 (bit 4) must be cleared when PLLS is set.
   - VDIV (bits 3-0) set to %1000, or multiply-by-32 because 1 MHz reference * 32= 32MHz. In BLPE mode, the configuration of the VDIV bits does not matter because the PLL is disabled. Changing them only sets up the multiply value for PLL usage in PBE mode

4 Flowchart of FEI to PEE Mode Transition using an 8 MHz crystal

Location:	Section 8.5.3.1, Page 190

The "MCGC3 = $58" in top right box of flowchart should be"MCGC3 = $48". The correct figure should be:

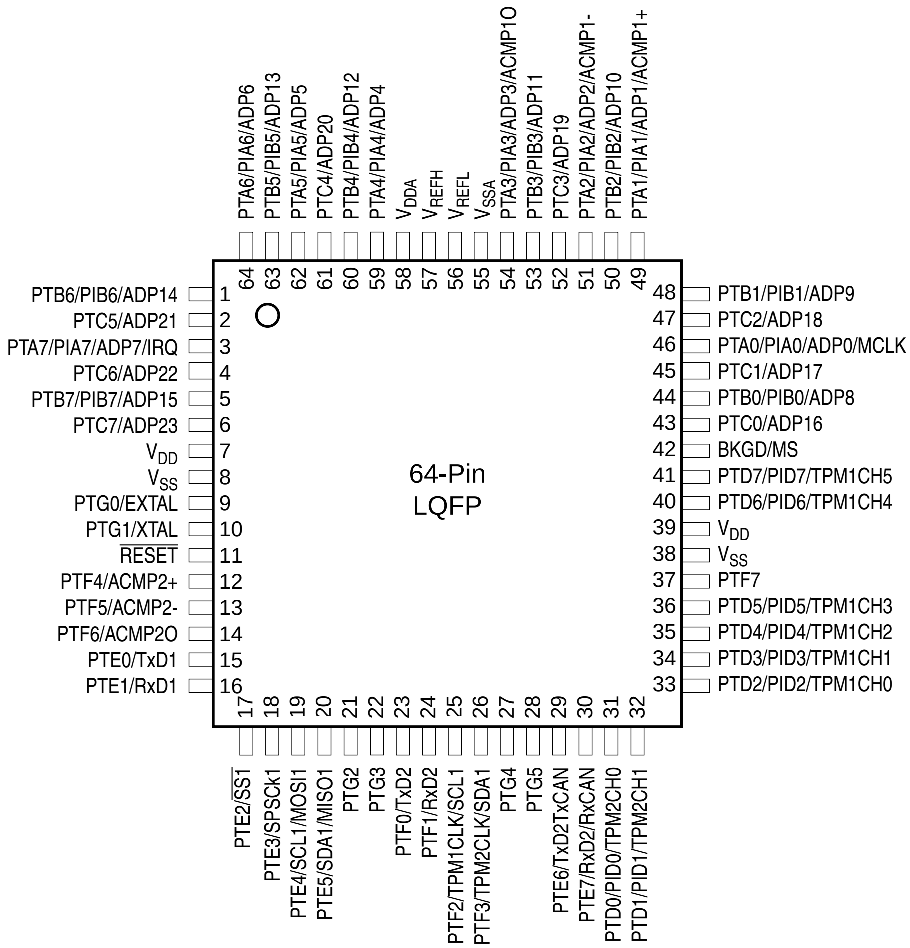


Figure 2-2. MC9S08DZ128 Series in 64-Pin LQFP Package

4.6.7 Block Protection

The block protection feature prevents the protected region of FLASH or EEPROM from program or erase changes. Block protection is controlled through the FLASH and EEPROM protection register (FPROT). The EPS bits determine the protected region of EEPROM and the FPS bits determine the protected region of FLASH. See Section 4.6.11.4, "FLASH and EEPROM Protection Register (FPROT and NVPROT)."

After exit from reset, FPROT is loaded with the contents of the NVPROT location, which is in the nonvolatile register block of the FLASH memory. FPROT cannot be changed directly from application software so a runaway program cannot alter the block protection settings. Because NVPROT is within the last sector of FLASH, if any amount of memory is protected, NVPROT is itself protected and cannot be altered (intentionally or unintentionally) by the application software. FPROT can be written through background debug commands, which provides a way to erase and reprogram protected FLASH memory.

One use for block protection is to block protect an area of FLASH memory for a bootloader program. This bootloader program then can be used to erase the rest of the FLASH memory and reprogram it. The bootloader is protected even if MCU power is lost during an erase and reprogram operation.

4.6.8 Vector Redirection

Whenever any FLASH is block protected, the reset and interrupt vectors will be protected. Vector redirection allows users to modify interrupt vector information without unprotecting bootloader and reset vector space. Vector redirection is enabled by programming the FNORED bit in the NVOPT register to 0. For redirection to occur, at least some portion of the FLASH memory must be block protected by programming the FPS bits in the NVPROT register. All interrupt vectors (memory locations 0x0_FF80 through 0x0_FFFD) are redirected, though the reset vector (0x0_FFFE:0x0_FFFF) is not.

For example, if 8192 bytes of FLASH are protected, the protected address region is from 0x0_E000 through 0x0_FFFF. The interrupt vectors (0x0_FF80 through 0x0_FFFD) are redirected to the locations 0x0_DF80 through 0x0_DFFD. If vector redirection is enabled and an interrupt occurs, the values in the locations 0x0_DFE0:0x0_DFE1 are used for the vector instead of the values in the locations 0x0_FFE0:0x0FFE1. This allows the user to reprogram the unprotected portion of the FLASH with new program code including new interrupt vector values while leaving the protected area, which includes the default vector locations, unchanged.

4.6.9 Security

The MC9S08DZ128 Series includes circuitry to prevent unauthorized access to the contents of FLASH, EEPROM, and RAM memory. When security is engaged, FLASH, EEPROM, and RAM are considered secure resources. Direct-page registers, high-page registers, and the background debug controller are considered unsecured resources. Programs executing within secure memory have normal access to any MCU memory locations and resources. Attempts to access a secure memory location with a program executing from an unsecured memory space or through the background debug interface are blocked (writes are ignored and reads return all 0s).

Security is engaged or disengaged based on the state of two register bits (SEC[1:0]) in the FOPT register. During reset, the contents of the nonvolatile location NVOPT are copied from FLASH into the working FOPT register in high-page register space. A user engages security by programming the NVOPT location,

5.8.8 System Power Management Status and Control 2 Register (SPMSC2)

This register is used to report the status of the low-voltage warning function, and to configure the stop mode behavior of the MCU. This register should be written during the user's reset initialization program to set the desired controls even if the desired settings are the same as the reset settings.

	7	6	5	4	3	2	1	0
R	0	0	LVDV[1]	LVWV	PPDF	0	0	PPDC[2]
W						PPDACK		
Power-on Reset:	0	0	0	0	0	0	0	0
LVD Reset:	0	0	u	u	0	0	0	0
Any other Reset:	0	0	u	u	0	0	0	0

= Unimplemented or Reserved   u = Unaffected by reset

[1] This bit can be written only one time after power-on reset. Additional writes are ignored.
[2] This bit can be written only one time after reset. Additional writes are ignored.

Figure 5-10. System Power Management Status and Control 2 Register (SPMSC2)

Table 5-11. SPMSC2 Register Field Descriptions

Field	Description
5 LVDV	**Low-Voltage Detect Voltage Select** — This write-once bit selects the low-voltage detect (LVD) trip point setting. It also selects the warning voltage range. See Table 5-12.
4 LVWV	**Low-Voltage Warning Voltage Select** — This bit selects the low-voltage warning (LVW) trip point voltage. See Table 5-12.
3 PPDF	**Partial Power Down Flag** — This read-only status bit indicates that the MCU has recovered from stop2 mode. 0 MCU has not recovered from stop2 mode. 1 MCU recovered from stop2 mode.
2 PPDACK	**Partial Power Down Acknowledge** — Writing a 1 to PPDACK clears the PPDF bit.
0 PPDC	**Partial Power Down Control** — This write-once bit controls whether stop2 or stop3 mode is selected. 0 Stop3 mode enabled. 1 Stop2, partial power down, mode enabled.

Table 5-12. LVD and LVW Trip Point Typical Values[1]

LVDV:LVWV	LVW Trip Point	LVD Trip Point
0:0	V_{LVW0} = 2.74 V	V_{LVD0} = 2.56 V
0:1	V_{LVW1} = 2.92 V	
1:0	V_{LVW2} = 4.3 V	V_{LVD1} = 4.0 V
1:1	V_{LVW3} = 4.6 V	

[1] See Appendix A, "Electrical Characteristics" for minimum and maximum values.

6.5.7 Port G Registers

Port G is controlled by the registers listed below.

6.5.7.1 Port G Data Register (PTGD)

	7	6	5	4	3	2	1	0
R W	PTGD7	PTGD6	PTGD5	PTGD4	PTGD3	PTGD2	PTGD1	PTGD0
Reset:	0	0	0	0	0	0	0	0

Figure 6-42. Port G Data Register (PTGD)

Table 6-40. PTGD Register Field Descriptions

Field	Description
7:0 PTGD[7:0]	**Port G Data Register Bits** — For port G pins that are inputs, reads return the logic level on the pin. For port G pins that are configured as outputs, reads return the last value written to this register. Writes are latched into all bits of this register. For port G pins that are configured as outputs, the logic level is driven out the corresponding MCU pin. Reset forces PTGD to all 0s, but these 0s are not driven out the corresponding pins because reset also configures all port pins as high-impedance inputs with pull-ups disabled.

6.5.7.2 Port G Data Direction Register (PTGDD)

	7	6	5	4	3	2	1	0
R W	PTGDD7	PTGDD6	PTGDD5	PTGDD4	PTGDD3	PTGDD2	PTGDD1	PTGDD0
Reset:	0	0	0	0	0	0	0	0

Figure 6-43. Port G Data Direction Register (PTGDD)

Table 6-41. PTGDD Register Field Descriptions

Field	Description
7:0 PTGDD[7:0]	**Data Direction for Port G Bits** — These read/write bits control the direction of port G pins and what is read for PTGD reads. 0 Input (output driver disabled) and reads return the pin value. 1 Output driver enabled for port G bit n and PTGD reads return the contents of PTGDn.

8.1.2 Modes of Operation

There are several modes of operation for the MCG:

- FLL Engaged Internal (FEI)
- FLL Engaged External (FEE)
- FLL Bypassed Internal (FBI)
- FLL Bypassed External (FBE)
- PLL Engaged External (PEE)
- PLL Bypassed External (PBE)
- Bypassed Low Power Internal (BLPI)
- Bypassed Low Power External (BLPE)
- Stop

For details see Section 8.4.1, “Operational Modes.

8.2 External Signal Description

There are no MCG signals that connect off chip.

Table 8-7. MCG Control Register 3 Field Descriptions (continued)

Field	Description
4 DIV32	**Divide-by-32 Enable** — Controls an additional divide-by-32 factor to the external reference clock for the FLL when RANGE bit is set. When the RANGE bit is 0, this bit has no effect. Writes to this bit are ignored if PLLS bit is set. 0 Divide-by-32 is disabled. 1 Divide-by-32 is enabled when RANGE=1.
3:0 VDIV	**VCO Divider** — Selects the amount to divide down the VCO output of PLL. The VDIV bits establish the multiplication factor (M) applied to the reference clock frequency. 0000 Encoding 0 — Reserved. 0001 Encoding 1 — Multiply by 4. 0010 Encoding 2 — Multiply by 8. 0011 Encoding 3 — Multiply by 12. 0100 Encoding 4 — Multiply by 16. 0101 Encoding 5 — Multiply by 20. 0110 Encoding 6 — Multiply by 24. 0111 Encoding 7 — Multiply by 28. 1000 Encoding 8 — Multiply by 32. 1001 Encoding 9 — Multiply by 36. 1010 Encoding 10 — Multiply by 40. 1011 Encoding 11 — Reserved (default to M=40). 11xx Encoding 12-15 — Reserved (default to M=40).

	7	6	5	4	3	2	1	0
R	COCO	AIEN	ADCO	ADCH				
W								
Reset:	0	0	0	1	1	1	1	1

Figure 10-3. Status and Control Register (ADCSC1)

Table 10-3. ADCSC1 Field Descriptions

Field	Description
7 COCO	Conversion Complete Flag. The COCO flag is a read-only bit set each time a conversion is completed when the compare function is disabled (ACFE = 0). When the compare function is enabled (ACFE = 1), the COCO flag is set upon completion of a conversion only if the compare result is true. This bit is cleared when ADCSC1 is written or when ADCRL is read. 0 Conversion not completed 1 Conversion completed
6 AIEN	Interrupt Enable AIEN enables conversion complete interrupts. When COCO becomes set while AIEN is high, an interrupt is asserted. 0 Conversion complete interrupt disabled 1 Conversion complete interrupt enabled
5 ADCO	Continuous Conversion Enable. ADCO enables continuous conversions. 0 One conversion following a write to the ADCSC1 when software triggered operation is selected, or one conversion following assertion of ADHWT when hardware triggered operation is selected. 1 Continuous conversions initiated following a write to ADCSC1 when software triggered operation is selected. Continuous conversions are initiated by an ADHWT event when hardware triggered operation is selected.
4:0 ADCH	Input Channel Select. The ADCH bits form a 5-bit field that selects one of the input channels. The input channels are detailed in Table 10-4. The successive approximation converter subsystem is turned off when the channel select bits are all set. This feature allows for explicit disabling of the ADC and isolation of the input channel from all sources. Terminating continuous conversions this way prevents an additional, single conversion from being performed. It is not necessary to set the channel select bits to all ones to place the ADC in a low-power state when continuous conversions are not enabled because the module automatically enters a low-power state when a conversion completes.

Table 10-4. Input Channel Select

ADCH	Input Select
00000–01111	AD0–15
10000–11011	AD16–27
11100	Reserved
11101	V_{REFH}
11110	V_{REFL}
11111	Module disabled

11.3.5 IIC Data I/O Register (IICxD)

	7	6	5	4	3	2	1	0
R	DATA							
W								
Reset	0	0	0	0	0	0	0	0

Figure 11-7. IIC Data I/O Register (IICxD)

Table 11-8. IICxD Field Descriptions

Field	Description
7–0 DATA	**Data** — In master transmit mode, when data is written to the IICxD, a data transfer is initiated. The most significant bit is sent first. In master receive mode, reading this register initiates receiving of the next byte of data.

NOTE

When transitioning out of master receive mode, the IIC mode should be switched before reading the IICxD register to prevent an inadvertent initiation of a master receive data transfer.

In slave mode, the same functions are available after an address match has occurred.

The TX bit in IICxC must correctly reflect the desired direction of transfer in master and slave modes for the transmission to begin. For instance, if the IIC is configured for master transmit but a master receive is desired, reading the IICxD does not initiate the receive.

Reading the IICxD returns the last byte received while the IIC is configured in master receive or slave receive modes. The IICxD does not reflect every byte transmitted on the IIC bus, nor can software verify that a byte has been written to the IICxD correctly by reading it back.

In master transmit mode, the first byte of data written to IICxD following assertion of MST is used for the address transfer and should comprise of the calling address (in bit 7 to bit 1) concatenated with the required R/$\overline{\text{W}}$ bit (in position bit 0).

11.3.6 IIC Control Register 2 (IICxC2)

	7	6	5	4	3	2	1	0
R	GCAEN	ADEXT	0	0	0	AD10	AD9	AD8
W								
Reset	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 11-8. IIC Control Register (IICxC2)

Arbitration is lost in the following circumstances:

- SDA sampled as a low when the master drives a high during an address or data transmit cycle.
- SDA sampled as a low when the master drives a high during the acknowledge bit of a data receive cycle.
- A start cycle is attempted when the bus is busy.
- A repeated start cycle is requested in slave mode.
- A stop condition is detected when the master did not request it.

This bit must be cleared by software writing a 1 to it.

Table 12-5. Baud Rate Prescaler

BRP5	BRP4	BRP3	BRP2	BRP1	BRP0	Prescaler value (P)
0	0	0	0	0	0	1
0	0	0	0	0	1	2
0	0	0	0	1	0	3
0	0	0	0	1	1	4
:	:	:	:	:	:	:
1	1	1	1	1	1	64

12.3.4 MSCAN Bus Timing Register 1 (CANBTR1)

The CANBTR1 register configures various CAN bus timing parameters of the MSCAN module.

	7	6	5	4	3	2	1	0
R W	SAMP	TSEG22	TSEG21	TSEG20	TSEG13	TSEG12	TSEG11	TSEG10
Reset:	0	0	0	0	0	0	0	0

Figure 12-7. MSCAN Bus Timing Register 1 (CANBTR1)

Read: Anytime
Write: Anytime in initialization mode (INITRQ = 1 and INITAK = 1)

Table 12-6. CANBTR1 Register Field Descriptions

Field	Description
7 SAMP	**Sampling** — This bit determines the number of CAN bus samples taken per bit time. 0 One sample per bit. 1 Three samples per bit[1]. If SAMP = 0, the resulting bit value is equal to the value of the single bit positioned at the sample point. If SAMP = 1, the resulting bit value is determined by using majority rule on the three total samples. For higher bit rates, it is recommended that only one sample is taken per bit time (SAMP = 0).
6:4 TSEG2[2:0]	**Time Segment 2** — Time segments within the bit time fix the number of clock cycles per bit time and the location of the sample point (see Figure 12-43). Time segment 2 (TSEG2) values are programmable as shown in Table 12-7.
3:0 TSEG1[3:0]	**Time Segment 1** — Time segments within the bit time fix the number of clock cycles per bit time and the location of the sample point (see Figure 12-43). Time segment 1 (TSEG1) values are programmable as shown in Table 12-8.

[1] In this case, PHASE_SEG1 must be at least 2 time quanta (Tq).

Instead of hardware interrupts, software polling may be used to monitor the TDRE and TC status flags if the corresponding TIE or TCIE local interrupt masks are 0s.

When a program detects that the receive data register is full (RDRF = 1), it gets the data from the receive data register by reading SCIxD. The RDRF flag is cleared by reading SCIxS1 while RDRF = 1 and then reading SCIxD.

When polling is used, this sequence is naturally satisfied in the normal course of the user program. If hardware interrupts are used, SCIxS1 must be read in the interrupt service routine (ISR). Normally, this is done in the ISR anyway to check for receive errors, so the sequence is automatically satisfied.

The IDLE status flag includes logic that prevents it from getting set repeatedly when the RxD line remains idle for an extended period of time. IDLE is cleared by reading SCIxS1 while IDLE = 1 and then reading SCIxD. After IDLE has been cleared, it cannot become set again until the receiver has received at least one new character and has set RDRF.

If the associated error was detected in the received character that caused RDRF to be set, the error flags — noise flag (NF), framing error (FE), and parity error flag (PF) — get set at the same time as RDRF. These flags are not set in overrun cases.

If RDRF was already set when a new character is ready to be transferred from the receive shifter to the receive data buffer, the overrun (OR) flag gets set instead the data along with any associated NF, FE, or PF condition is lost.

At any time, an active edge on the RxD serial data input pin causes the RXEDGIF flag to set. The RXEDGIF flag is cleared by writing a “1” to it. This function does depend on the receiver being enabled (RE = 1).

14.3.5 Additional SCI Functions

The following sections describe additional SCI functions.

14.3.5.1 8- and 9-Bit Data Modes

The SCI system (transmitter and receiver) can be configured to operate in 9-bit data mode by setting the M control bit in SCIxC1. In 9-bit mode, there is a ninth data bit to the left of the MSB of the SCI data register. For the transmit data buffer, this bit is stored in T8 in SCIxC3. For the receiver, the ninth bit is held in R8 in SCIxC3.

For coherent writes to the transmit data buffer, write to the T8 bit before writing to SCIxD.

If the bit value to be transmitted as the ninth bit of a new character is the same as for the previous character, it is not necessary to write to T8 again. When data is transferred from the transmit data buffer to the transmit shifter, the value in T8 is copied at the same time data is transferred from SCIxD to the shifter.

9-bit data mode typically is used in conjunction with parity to allow eight bits of data plus the parity in the ninth bit. Or it is used with address-mark wakeup so the ninth data bit can serve as the wakeup bit. In custom protocols, the ninth bit can also serve as a software-controlled marker.

Reset clears the TPM counter registers. Writing any value to TPMxCNTH or TPMxCNTL also clears the TPM counter (TPMxCNTH:TPMxCNTL) and resets the coherency mechanism, regardless of the data involved in the write.

	7	6	5	4	3	2	1	0
R	Bit 15	14	13	12	11	10	9	Bit 8
W	Any write to TPMxCNTH clears the 16-bit counter							
Reset	0	0	0	0	0	0	0	0

Figure 16-8. TPM Counter Register High (TPMxCNTH)

	7	6	5	4	3	2	1	0
R	Bit 7	6	5	4	3	2	1	Bit 0
W	Any write to TPMxCNTL clears the 16-bit counter							
Reset	0	0	0	0	0	0	0	0

Figure 16-9. TPM Counter Register Low (TPMxCNTL)

When BDM is active, the timer counter is frozen (this is the value that will be read by user); the coherency mechanism is frozen such that the buffer latches remain in the state they were in when the BDM became active, even if one or both counter halves are read while BDM is active. This assures that if the user was in the middle of reading a 16-bit register when BDM became active, it will read the appropriate value from the other half of the 16-bit value after returning to normal execution.

In BDM mode, writing any value to TPMxSC, TPMxCNTH or TPMxCNTL registers resets the read coherency mechanism of the TPMxCNTH:L registers, regardless of the data involved in the write.

16.3.3 TPM Counter Modulo Registers (TPMxMODH:TPMxMODL)

The read/write TPM modulo registers contain the modulo value for the TPM counter. After the TPM counter reaches the modulo value, the TPM counter resumes counting from 0x0000 at the next clock, and the overflow flag (TOF) becomes set. Writing to TPMxMODH or TPMxMODL inhibits the TOF bit and overflow interrupts until the other byte is written. Reset sets the TPM counter modulo registers to 0x0000 which results in a free running timer counter (modulo disabled).

Writing to either byte (TPMxMODH or TPMxMODL) latches the value into a buffer and the registers are updated with the value of their write buffer according to the value of CLKSB:CLKSA bits, so:

- If (CLKSB:CLKSA = 0:0), then the registers are updated when the second byte is written
- If (CLKSB:CLKSA not = 0:0), then the registers are updated after both bytes were written, and the TPM counter changes from (TPMxMODH:TPMxMODL - 1) to (TPMxMODH:TPMxMODL). If the TPM counter is a free-running counter, the update is made when the TPM counter changes from 0xFFFE to 0xFFFF

The latching mechanism may be manually reset by writing to the TPMxSC address (whether BDM is active or not).

the TPM counter is a free-running counter then the update is made when the TPM counter changes from 0xFFFE to 0xFFFF.

16.4.2.4 Center-Aligned PWM Mode

This type of PWM output uses the up/down counting mode of the timer counter (CPWMS=1). The output compare value in TPMxCnVH:TPMxCnVL determines the pulse width (duty cycle) of the PWM signal while the period is determined by the value in TPMxMODH:TPMxMODL. TPMxMODH:TPMxMODL should be kept in the range of 0x0001 to 0x7FFF because values outside this range can produce ambiguous results. ELSnA will determine the polarity of the CPWM output.

pulse width = 2 x (TPMxCnVH:TPMxCnVL)

period = 2 x (TPMxMODH:TPMxMODL); TPMxMODH:TPMxMODL=0x0001-0x7FFF

If the channel-value register TPMxCnVH:TPMxCnVL is zero or negative (bit 15 set), the duty cycle will be 0%. If TPMxCnVH:TPMxCnVL is a positive value (bit 15 clear) and is greater than the (non-zero) modulus setting, the duty cycle will be 100% because the duty cycle compare will never occur. This implies the usable range of periods set by the modulus register is 0x0001 through 0x7FFE (0x7FFF if you do not need to generate 100% duty cycle). This is not a significant limitation. The resulting period would be much longer than required for normal applications.

TPMxMODH:TPMxMODL=0x0000 is a special case that should not be used with center-aligned PWM mode. When CPWMS=0, this case corresponds to the counter running free from 0x0000 through 0xFFFF, but when CPWMS=1 the counter needs a valid match to the modulus register somewhere other than at 0x0000 in order to change directions from up-counting to down-counting.

The output compare value in the TPM channel registers (times 2) determines the pulse width (duty cycle) of the CPWM signal (Figure 16-16). If ELSnA=0, a compare occurred while counting up forces the CPWM output signal low and a compare occurred while counting down forces the output high. The counter counts up until it reaches the modulo setting in TPMxMODH:TPMxMODL, then counts down until it reaches zero. This sets the period equal to two times TPMxMODH:TPMxMODL.

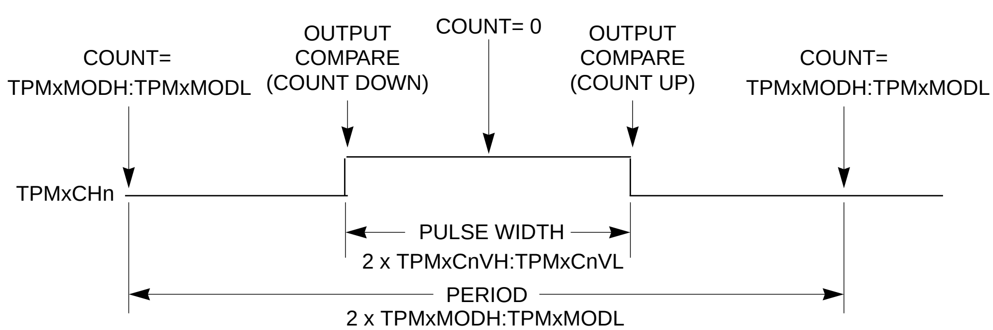


Figure 16-16. CPWM Period and Pulse Width (ELSnA=0)

Center-aligned PWM outputs typically produce less noise than edge-aligned PWMs because fewer I/O pin transitions are lined up at the same system clock edge. This type of PWM is also required for some types of motor drives.

17.2.3 BDC Commands

BDC commands are sent serially from a host computer to the BKGD pin of the target HCS08 MCU. All commands and data are sent MSB-first using a custom BDC communications protocol. Active background mode commands require that the target MCU is currently in the active background mode while non-intrusive commands may be issued at any time whether the target MCU is in active background mode or running a user application program.

Table 17-1 shows all HCS08 BDC commands, a shorthand description of their coding structure, and the meaning of each command.

Coding Structure Nomenclature

This nomenclature is used in Table 17-1 to describe the coding structure of the BDC commands.

		Commands begin with an 8-bit hexadecimal command code in the host-to-target direction (most significant bit first)
/	=	separates parts of the command
d	=	delay 16 target BDC clock cycles
AAAA	=	a 16-bit address in the host-to-target direction
RD	=	8 bits of read data in the target-to-host direction
WD	=	8 bits of write data in the host-to-target direction
RD16	=	16 bits of read data in the target-to-host direction
WD16	=	16 bits of write data in the host-to-target direction
SS	=	the contents of BDCSCR in the target-to-host direction (STATUS)
CC	=	8 bits of write data for BDCSCR in the host-to-target direction (CONTROL)
RBKP	=	16 bits of read data in the target-to-host direction (from BDCBKPT breakpoint register)
WBKP	=	16 bits of write data in the host-to-target direction (for BDCBKPT breakpoint register)

in the DBGCNT register at the end of a trace run, the number of valid words can be determined. The FIFO data is read by optionally reading the DBGFX and DBGFH registers followed by the DBGFL register. Each time the DBGFL register is read the FIFO is shifted to allow reading of the next word however the count does not decrement. In event-only trigger modes where the FIFO will contain only the data bus values stored, to read the FIFO only DBGFL needs to be accessed.

The FIFO is normally only read while ARM and ARMF=0, however reading the FIFO while the DBG module is armed will return the data value in the oldest location of the FIFO and the TBC will not allow the FIFO to shift. This action could cause a valid entry to be lost because the unexpected read blocked the FIFO advance.

If the DBG module is not armed and the DBGFL register is read, the TBC will store the current opcode address. Through periodic reads of the DBGFX, DBGFH, and DBGFL registers while the DBG module is not armed, host software can provide a histogram of program execution. This is called profile mode. Since the full 17-bit address and the signal that indicates whether an address is in paged extended memory are captured on each FIFO store, profile mode works correctly over the entire extended memory map.

18.4.6 Interrupt Priority

When TRGSEL is set and the DBG module is armed to trigger on begin- or end-trigger types, a trigger is not detected in the condition where a pending interrupt occurs at the same time that a target address reaches the top of the instruction pipe. In these conditions, the pending interrupt has higher priority and code execution switches to the interrupt service routine.

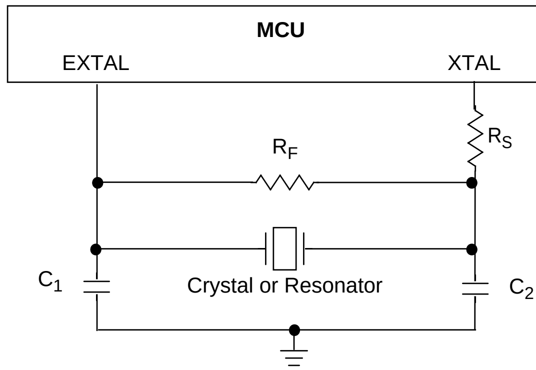
When TRGSEL is clear and the DBG module is armed to trigger on end-trigger types, the trigger event is detected on a program fetch of the target address, even when an interrupt becomes pending on the same cycle. In these conditions, the pending interrupt has higher priority, the exception is processed by the core and the interrupt vector is fetched. Code execution is halted before the first instruction of the interrupt service routine is executed. In this scenario, the DBG module will have cleared ARM without having recorded the change-of-flow that occurred as part of the interrupt exception. Note that the stack will hold the return addresses and can be used to reconstruct execution flow in this scenario.

When TRGSEL is clear and the DBG module is armed to trigger on begin-trigger types, the trigger event is detected on a program fetch of the target address, even when an interrupt becomes pending on the same cycle. In this scenario, the FIFO captures the change of flow event. Because the system is configured for begin-trigger, the DBG remains armed and does not break until the FIFO has been filled by subsequent change of flow events.

18.5 Resets

The DBG module cannot cause an MCU reset.

There are two different ways this module will respond to reset depending upon the conditions before the reset event. If the DBG module was setup for an end trace run with DBGEN=1 and BEGIN=0, ARM, ARMF, and BRKEN are cleared but the reset function on most DBG control and status bits is overridden so a host development system can read out the results of the trace run after the MCU has been reset. In all other cases including POR, the DBG module controls are initialized to start a begin trace run starting from when the reset vector is fetched. The conditions for the default begin trace run are:



A.11 MCG Specifications

Table A-12. MCG Frequency Specifications (Temperature Range = –40 to 125°C Ambient)

Num	C	Rating		Symbol	Min	Typical	Max	Unit
1	P	Internal reference frequency - factory trimmed at VDD=5.0V and temperature=25C		f_{int_ft}	—	31.25	—	kHz
2	P	Internal reference frequency - untrimmed [1]		f_{int_ut}	25	36	41.66	kHz
3	P	Internal reference frequency - user trimmed		f_{int_t}	31.25	—	39.0625	kHz
4	D	Internal reference startup time		t_{irefst}	—	55	100	us
5	—	DCO output frequency range - untrimmed [1]	Low range (DRS=0, DMX32=0) f_{dco_ut} = 512X f_{int_ut}	f_{dco_ut}	12.8	18.43	21.33	MHz
	—		Mid range (DRS=1, DMX32=0) f_{dco_ut} = 1024 X f_{int_ut}		25.6	36.86	42.66	
6	P	DCO output frequency range - trimmed[2]	Low range (DRS=0, DMX32=0) f_{dco_ut} = 512X f_{int_ut}	f_{dco_t}	16	—	20	MHz
	P		Mid range (DRS=1, DMX32=0) f_{dco_ut} = 1024 X f_{int_ut}		32	—	40	
7	C	Resolution of trimmed DCO output frequency at fixed voltage and temperature (using FTRIM)		$\Delta f_{dco\_res\_t}$	—	$\pm$0.1	$\pm$0.2	$\%f_{dco}$
8	C	Resolution of trimmed DCO output frequency at fixed voltage and temperature (not using FTRIM)		$\Delta f_{dco\_res\_t}$	—	$\pm$0.2	$\pm$0.4	$\%f_{dco}$
9	P	Total deviation of trimmed DCO output frequency over voltage and temperature		Δf_{dco_t}	—	+ 0.5 -1.0	$\pm$2	$\%f_{dco}$
10	C	Total deviation of trimmed DCO output frequency over fixed voltage and temperature range of 0 - 70 °C		Δf_{dco_t}	—	$\pm$0.5	$\pm$1	$\%f_{dco}$
11	C	FLL acquisition time [3]		$t_{fll\_acquire}$	—	—	1	ms
12	D	PLL acquisition time [4]		$t_{pll\_acquire}$	—	—	1	ms
13	C	Long term Jitter of DCO output clock (averaged over 2mS interval) [5]		C_{Jitter}	—	0.02	0.2	$\%f_{dco}$
14	D	VCO operating frequency		f_{vco}	7.0	—	55.0	MHz

A.12.3 MSCAN

Table A-15. MSCAN Wake-up Pulse Characteristics

Num	C	Rating	Symbol	Min	Typ	Max	Unit
1	D	MSCAN Wake-up dominant pulse filtered	t_{WUP}	—	—	2	μs
2	D	MSCAN Wake-up dominant pulse pass	t_{WUP}	5	—	—	μs